

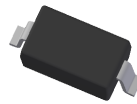
Features

- Low Forward Voltage Drop
- Low Reverse Leakage
- Excellent High Temperature Stability
- Patented Super Barrier Rectifier Technology (SBR[®])
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q101, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](#) or your local Diodes representative.**
- <https://www.diodes.com/quality/product-definitions/>

Mechanical Data

- Case: SOD123
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Leads: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208[Ⓜ]
- Polarity: Cathode Band
- Weight: 0.004 grams (Approximate)

SOD123



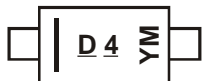
Top View

Ordering Information (Note 4)

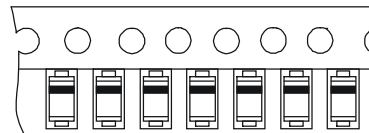
Part Number	Case	Packaging
SBR1A40S1-7	SOD123	3,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



D 4 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: G = 2019)
 M = Month (ex: 9 = September)



Date Code Key

Year	2004	~	2015	2016	2017	2018	2019	2020	2021	2022	2023	2024	2025	2026
Code	R	~	C	D	E	F	G	H	I	J	K	L	M	N

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitive load, derating current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	40	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_{RM}		
Average Rectified Output Current	I_O	1	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	20	A

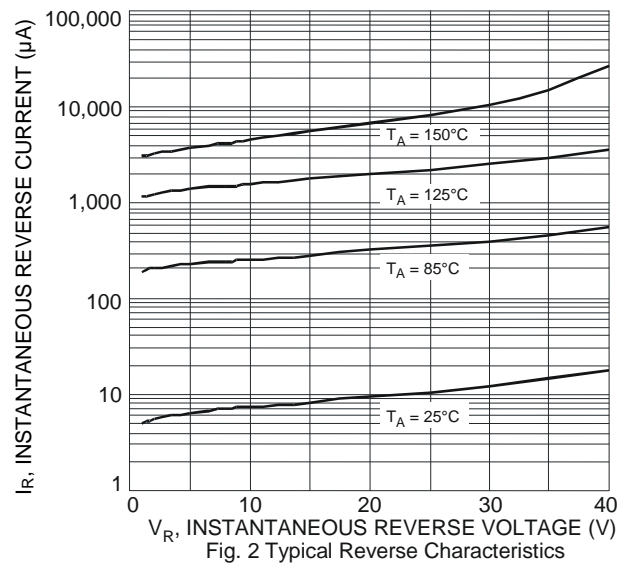
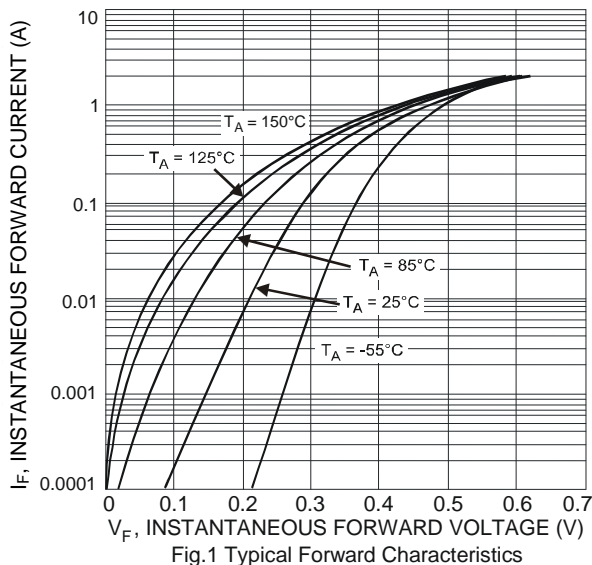
Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance	$R_{\theta JA}$	473	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	407	
Thermal Resistance Junction to Ambient (Note 6)	$R_{\theta JA}$	90	
Thermal Resistance Junction to Case (Note 5)	$R_{\theta JC}$	80	
Thermal Resistance Junction to Case (Note 6)	$R_{\theta JC}$	80	
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	$^\circ\text{C}$
Power Dissipation (Note 6)	P_D	320	mW

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V_F	—	—	0.52	V	$I_F = 1\text{A}, T_J = +25^\circ\text{C}$
		—	0.44	0.50		$I_F = 1\text{A}, T_J = +125^\circ\text{C}$
Leakage Current (Note 7)	I_R	—	18	200	μA	$V_R = 40\text{V}, T_J = +25^\circ\text{C}$
		—	4	—	mA	$V_R = 40\text{V}, T_J = +100^\circ\text{C}$

- Notes: 5. FR-4 PCB, 2 oz. copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
6. Device mounted on FR-4 substrate, 1" x 1", 2oz, copper, single-sided, PC boards.
7. Short duration pulse test used to minimize self-heating effect.



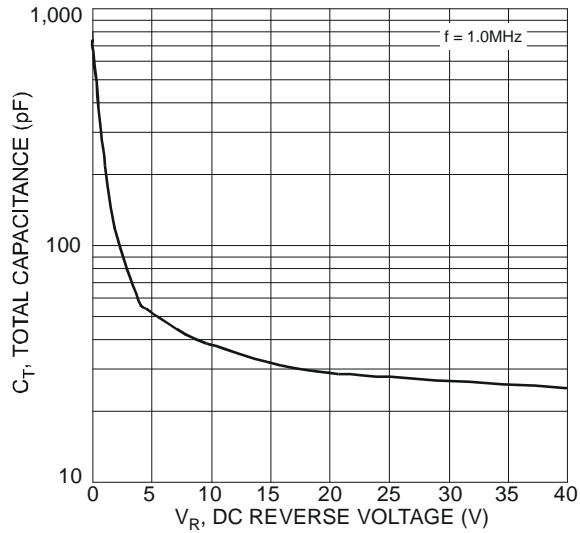


Fig. 3 Total Capacitance vs. Reverse Voltage

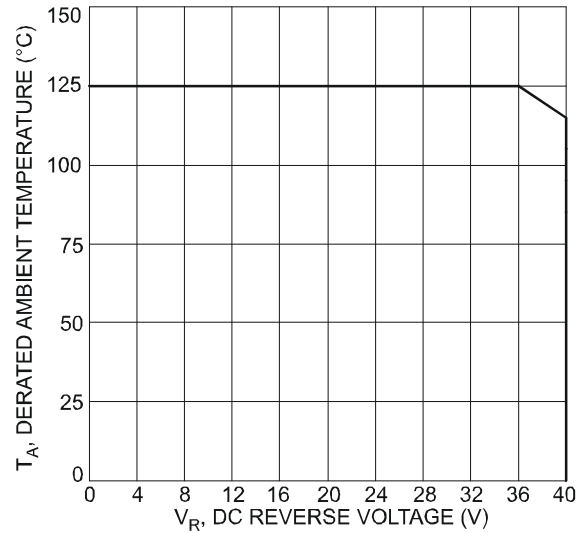


Fig. 4 Operating Temperature Derating

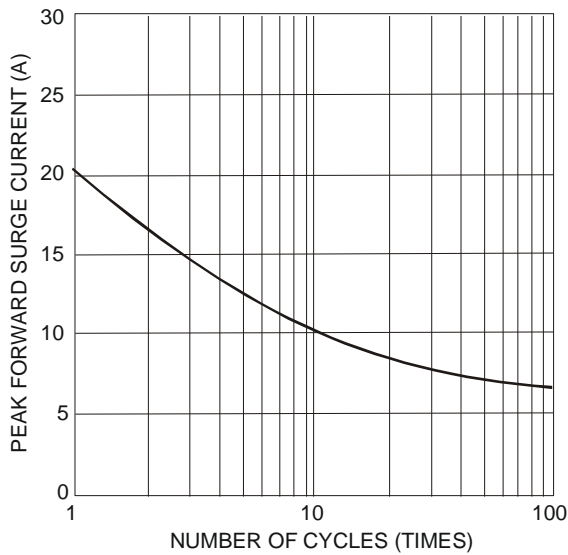


Fig. 5 Forward Surge Current & Number of Cycle

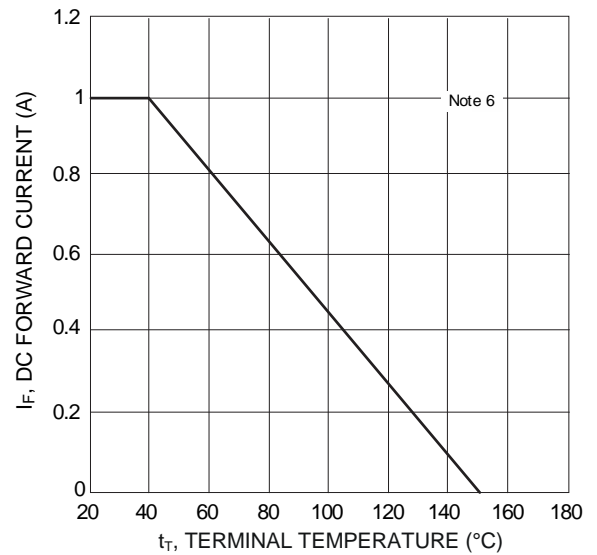
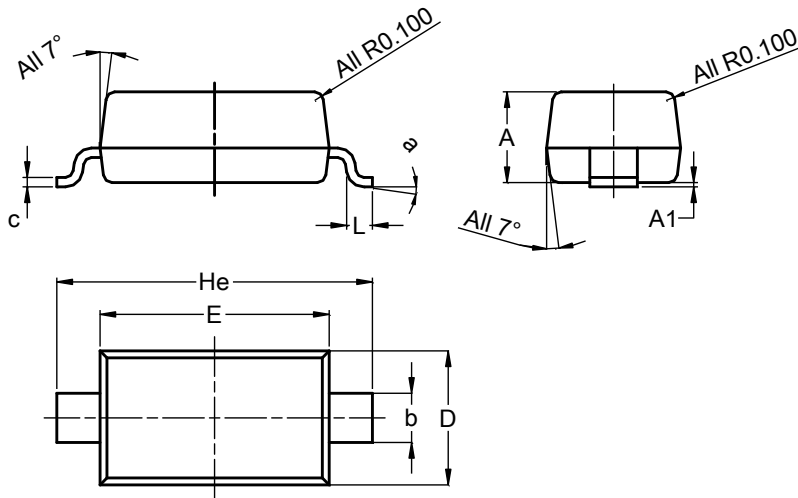


Fig. 6 DC Forward Current Derating

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD123

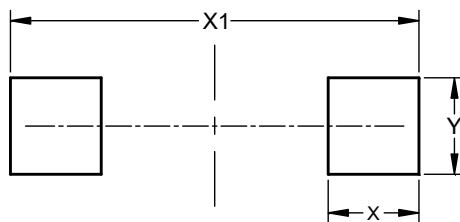


SOD123			
Dim	Min	Max	Typ
A	1.00	1.35	1.05
A1	0.00	0.10	0.05
b	0.52	0.62	0.57
c	0.10	0.15	0.11
D	1.40	1.70	1.55
E	2.55	2.85	2.65
He	3.55	3.85	3.65
L	0.25	0.40	0.30
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOD123



Dimensions	Value (in mm)
X	0.900
X1	4.050
Y	0.950

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